IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: : METHOD OF DETECTING

CHEMICAL MECHANICAL

SETHURAMAN JAYASHANKAR ET AL. : POLISHING ENDPOINTS IN

THIN FILM HEAD PROCESSES

:

Attorney Docket No. SEAG 63336

INFORMATION DISCLOSURE STATEMENT

June 25, 2003

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to the provisions of 37 CFR Sections 1.56, 1.97 and 1.98, Applicants submit herewith copies of the references cited on the attached Form PTO/SB/08A for consideration during prosecution of this application.

This Statement is filed solely for the purpose of complying with the pertinent rules of the Office and is not intended to be a substitute for an independent evaluation by the Examiner of the art cited or an independent search by the Examiner, and no representation of any nature is made or intended by the filing of this Statement.

Respectfully submitted,

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Substitute for form 1449A/PTO	Complete if Known				
INFORMATION DISCLOSURE	Application Number				
STATEMENT BY APPLICANT	Filing Date				
	First Named Inventor Sethuraman Jayashankar				
(use as many sheets as necessary)	Group Art Unit				
	Examiner Name				
Sheet 1 of 1	Attorney Docket Number SEAG 63336				

Examiner	Cita	U.S. Patent Document	U.S. PATENT DOCUMENTS	T			
Initials •	Cite No. ¹	U.S. Patent Document	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear		
		Number Kind Code ² (if known)					
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Unique citation designation number. 2See attached Kinds of U.S. Patent Documents, 1 Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). 4For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. Applicant is to place a check mark here if English language Translation is attached.

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